



Click [here](#) for the 3D model.

### Dimensions

Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

### Packaging Specifications

Packaging	Cut Reel
Packaging Quantity	50

### General Information

Series	COG HT 260C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, 260C
Features	High Temperature, Low ESR
RoHS	Yes
Termination	Gold
Marking	No
AEC-Q200	No
Component Weight	3.7 mg
Miscellaneous	Gold (Au) 30 - 70 micro inches.
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	1500 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+260°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30PPM/C, 1 kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms